

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Vishay Semiconductor/Diodes Division</u> <u>VS-HFA30TA60CSTRLP</u>

For any questions, you can email us directly: sales@integrated-circuit.com



Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



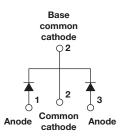
VS-HFA30TA60CSPbF

Vishay Semiconductors

HEXFRED®, Ultrafast Soft Recovery Diode, 2 x 15 A



TO-263AB (D²PAK)



PRODUCT SUMMARY						
Package	TO-263AB (D ² PAK)					
I _{F(AV)}	2 x 15 A					
V _R	600 V					
V _F at I _F	1.2 V					
t _{rr} (typ.)	19 ns					
T _J max.	150 °C					
Diode variation	Common cathode					

FEATURES

- · Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- · Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

BENEFITS

- · Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- · Reduced snubbing
- · Reduced parts count

DESCRIPTION

VS-HFA30TA60CS is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 15 A per leg continuous current, the VS-HFA30TA60CS is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the tb portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The VS-HFA30TA60CS is ideally suited HEXFRED applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is

PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Cathode to anode voltage	V _R		600	V
per leg	1	T 100 °C	15	
Maximum continuous forward current per device	e I _F	T _C = 100 °C	30	А
Single pulse forward current	I _{FSM}		150	
Maximum repetitive forward current	I _{FRM}		60	
Maximum power discinction	В	T _C = 25 °C	74	°C
Maximum power dissipation	P_D	T _C = 100 °C	29	
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	W

Revision: 26-Feb-16 1 Document Number: 94071

Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



www.vishay.com

VS-HFA30TA60CSPbF

Vishay Semiconductors

ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-	
Maximum forward voltage		I _F = 15 A	See fig. 1	-	1.3	1.7	V
	V_{FM}	I _F = 30 A		-	1.5	2.0	
		I _F = 15 A, T _J = 125 °C		-	1.2	1.6	
Maximum reverse		V _R = V _R rated	Coo fig. 0	-	1.0	10	
leakage current	I _{RM}	T _J = 125 °C, V _R = 0.8 x V _R rated	See fig. 2	-	400	1000	μΑ
Junction capacitance	C _T	V _R = 200 V	See fig. 3	-	25	50	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body		-	8.0	-	nH

DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS	
	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200$	A/μs, V _R = 30 V	-	19	-		
Reverse recovery time See fig. 5, 10	t _{rr1}	T _J = 25 °C		-	42	60	ns	
oce lig. 5, 10	t _{rr2}	T _J = 125 °C		-	70	90		
Peak recovery current	I _{RRM1}	T _J = 25 °C	I_F = 15 A dI_F/dt = 200 A/ μ s V_R = 200 V	-	4.0	6.0	- A - nC	
See fig. 6	I _{RRM2}	T _J = 125 °C		-	6.5	10		
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	80	180		
See fig. 7	Q _{rr2}	T _J = 125 °C		-	220	450		
Peak rate of fall of recovery current during t _b See fig. 8	dI _{(rec)M} /dt1	T _J = 25 °C		-	188	-	A/µs	
	dI _{(rec)M} /dt2	T _J = 125 °C		-	160	-	- Λ·μδ	

THERMAL - MECHANICAL SPECIFICATIONS PER LEG								
PARAMETER	TER SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS		
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C		
Junction to case, single leg conducting	В		-	-	1.7			
Junction to case, both legs conducting	R _{thJC}		-	-	0.85	K/W		
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80			
Weight			-	2.0	-	g		
vveignt			-	0.07	-	oz.		
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)		
Marking device		Case style TO-263AB (D2PAK)	HFA30TA60CS					

Revision: 26-Feb-16 2 Document Number: 94071





1.0

I_F - Instantaneous Forward Current (A)

VS-HFA30TA60CSPbF

Vishay Semiconductors

100 T_J = 150 °C T_J = 125 °C T_J = 25 °C



1.6

1.4

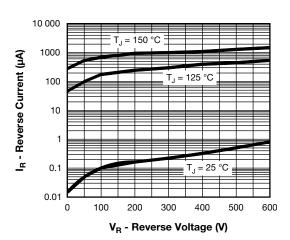
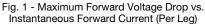


Fig. 2 - Typical Reverse Current vs. Reverse Voltage (Per Leg)



1.8

2.0

2.2

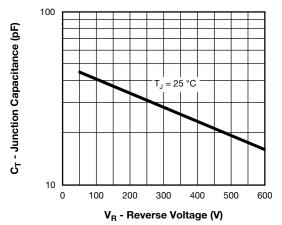


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

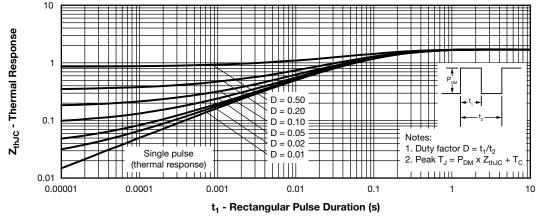


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite

Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

VS-HFA30TA60CSPbF

VISHAY.

www.vishay.com

Vishay Semiconductors

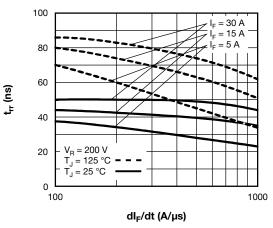


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

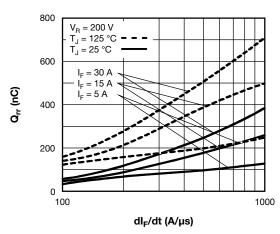


Fig. 7 - Typical Stored Charge vs. dl_F/dt (Per Leg)

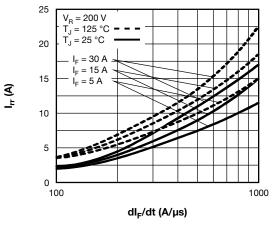


Fig. 6 - Typical Recovery Current vs. dl_F/dt (Per Leg)

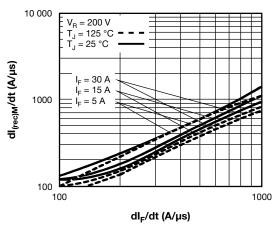


Fig. 8 - Typical dI_{(rec)M}/dt vs. dI_F/dt (Per Leg)

Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite

Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

VS-HFA30TA60CSPbF

VISHAY. www.vishay.com

Vishay Semiconductors

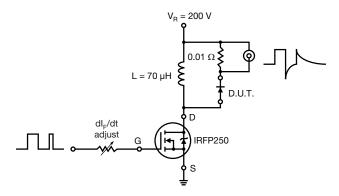
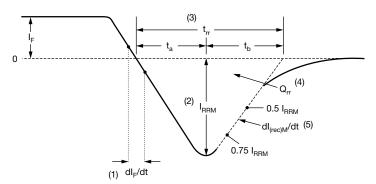


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dI_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RBM} and 0.50 I_{RBM} extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite

Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

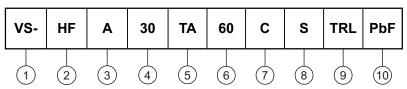


VS-HFA30TA60CSPbF

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product
- HEXFRED[®] family
- **3** Process designator: A = electron irradiated
- 4 Current rating (30 = 30 A)
- Package outline (TA = TO-220, 3 leads)
- 6 Voltage rating (60 = 600 V)
- 7 Circuit configuration (C = common cathode)
- S = D²PAK
- 9 • None = tube
 - TRL = tape and reel (left oriented)
 - TRR = tape and reel (right oriented)
- • PbF = lead (Pb)-free, for tube packaged
 - P = lead (Pb)-free, for tape and reel packaged

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-HFA30TA60CSPBF	50	1000	Antistatic plastic tube				
VS-HFA30TA60CSTRRP	800	800	13" diameter reel				
VS-HFA30TA60CSTRLP	800	800	13" diameter reel				

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95046</u>					
Part marking information	www.vishay.com/doc?95054				
Packaging information	www.vishay.com/doc?95032				

VISHAY

Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite

Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



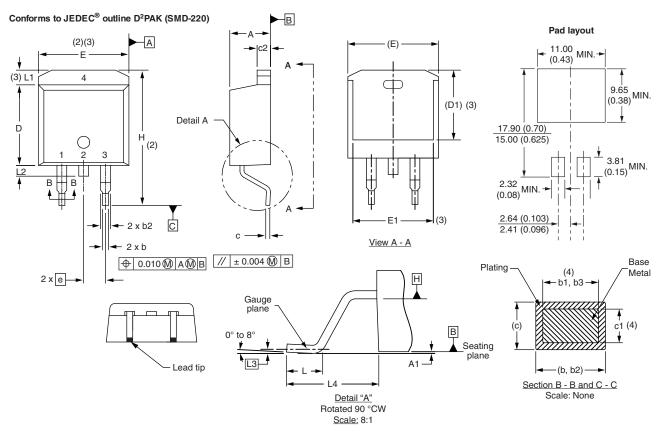
Outline Dimensions

Vishay Semiconductors

www.vishay.com

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
STINIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	ı	1.65	ı	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25	BSC	0.010 BSC		
L4	4.78	5.28	0.188	0.208	·

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 08-Jul-15 1 Document Number: 95046



Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite Datasheet of VS-HFA30TA60CSTRLP - DIODE ARRAY GP 600V 15A D2PAK

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



Legal Disclaimer Notice

Vishav

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 Document Number: 91000 1